AUTOMOTIVE GRADE

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HALOGEN FREE



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# Vishay General Semiconductor

# High Current Density Surface Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.34 \text{ V}$  at  $I_F = 4 \text{ A}$ 



#### ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	8.0 A		
$V_{RRM}$	45 V		
I <sub>FSM</sub>	140 A		
V <sub>F</sub> at I <sub>F</sub> = 8.0 A (T <sub>A</sub> = 125 °C)	0.41 V		
T <sub>J</sub> max.	150 °C		
Package	SMPC (TO-277A)		
Circuit configuration	Single		

#### **FEATURES**

- Very low profile typical height of 1.1 mm
- Ideal for automated placement
- Trench MOS Schottky technology
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
  - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in low voltage high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

## **MECHANICAL DATA**

Case: SMPC (TO-277A)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3\_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified

("\_X" denotes revision code e.g. A, B,....)

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V8P45	UNIT	
Device marking code		V845		
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	45	V	
Maximum average forward rectified current (fig. 1)	I <sub>F</sub> <sup>(1)</sup>	8.0	Α	
	I <sub>F</sub> <sup>(2)</sup>	4.3		
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	140	А	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>STG</sub>	-40 to +150	°C	

## Notes

- (1) Mounted on 30 mm x 30 mm pad areas aluminum PCB
- (2) Free air, mounted on recommended copper pad area



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 4.0 A	- T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.44	-	V
	I <sub>F</sub> = 8.0 A			0.49	0.58	
	I <sub>F</sub> = 4.0 A	T <sub>A</sub> = 125 °C		0.34	=	
	I <sub>F</sub> = 8.0 A			0.41	0.49	
Reverse current	V <sub>R</sub> = 45 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	-	0.6	- mA
	$V_R = 45 \text{ V}$ $T_A = 125 \text{ °C}$	T <sub>A</sub> = 125 °C		5.0	20	

#### **Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	V8P45	UNIT	
Typical thormal registance	R <sub>θJA</sub> (1)(2)	75	°C/W	
Typical thermal resistance	R <sub>0JM</sub> (3)	4		

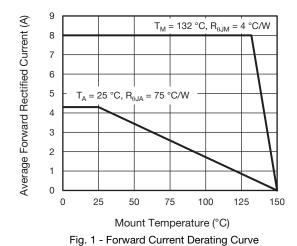
#### **Notes**

- $^{(1)}$  The heat generated must be less than the thermal conductivity from junction to ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$  Free air mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  junction to ambient
- $^{(3)}$  Mounted on 30 mm x 30 mm aluminum PCB; thermal resistance  $R_{\theta JM}$  junction to mount

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
V8P45-M3/86A	0.10	86A	1500	7" diameter plastic tape and reel	
V8P45-M3/87A	0.10	87A	6500	13" diameter plastic tape and reel	
V8P45HM3_A/H (1)	0.10	Н	1500	7" diameter plastic tape and reel	
V8P45HM3_A/I (1)	0.10	I	6500	13" diameter plastic tape and reel	

### Note

## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)



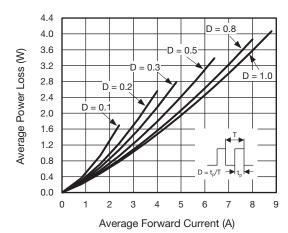


Fig. 2 - Forward Power Loss Characteristics

<sup>(1)</sup> AEC-Q101 qualified



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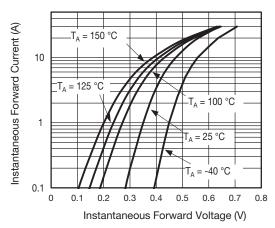


Fig. 3 - Typical Instantaneous Forward Characteristics

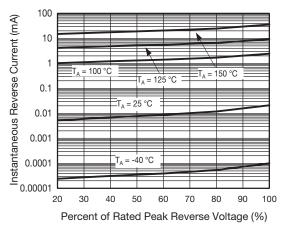


Fig. 4 - Typical Reverse Leakage Characteristics Per Diode

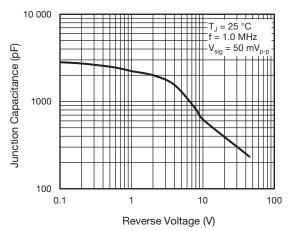


Fig. 5 - Typical Junction Capacitance

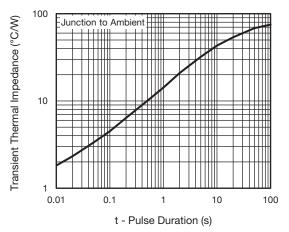
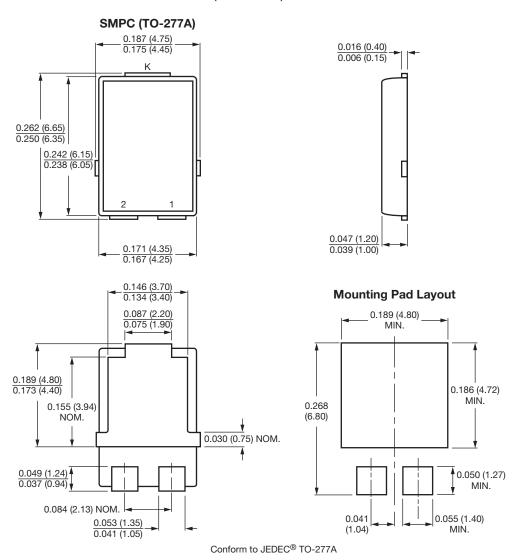


Fig. 6 - Typical Transient Thermal Impedance



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## **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)





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